International
IOR Rectifier

PD - 90495G

IRFM9140
JANTX2N7236
JANTXV2N7236
JANS2N7236
REF:MIL-PRF-19500/595
100V, P-CHANNEL
HEXFET® MOSFETTECHNOLOGY

POWER MOSFET
THRU-HOLE (TO-254AA)

Product Summary

Part Number	$R_{DS(on)}$	I_D
IRFM9140	0.20Ω	-18A

TO-254AA

HEXFET® MOSFET technology is the key to International Rectifier's advanced line of power MOSFET transistors. The efficient geometry design achieves very low on-state resistance combined with high transconductance. HEXFET transistors also feature all of the well-established advantages of MOSFETs, such as voltage control, very fast switching, ease of paralleling and electrical parameter temperature stability. They are well-suited for applications such as switching power supplies, motor controls, inverters, choppers, audio amplifiers, high energy pulse circuits, and virtually any application where high reliability is required. The HEXFET transistor's totally isolated package eliminates the need for additional isolating material between the device and the heatsink. This improves thermal efficiency and reduces drain capacitance.

Features:

- Simple Drive Requirements
- Ease of Paralleling
- Hermetically Sealed
- Electrically Isolated
- Dynamic dv/dt Rating
- Light-weight

Absolute Maximum Ratings

	Parameter		Units
I_D @ V_{GS} = -10V, T_C = 25°C	Continuous Drain Current	-18	A
I_D @ V_{GS} = -10V, T_C = 100°C	Continuous Drain Current	-11	
I_{DM}	Pulsed Drain Current ①	-72	
P_D @ T_C = 25°C	Max. Power Dissipation	125	W
	Linear Derating Factor	1.0	W/°C
V_{GS}	Gate-to-Source Voltage	±20	V
E_{AS}	Single Pulse Avalanche Energy ②	500	mJ
I_{AR}	Avalanche Current ①	-18	A
E_{AR}	Repetitive Avalanche Energy ①	12.5	mJ
dv/dt	Peak Diode Recovery dv/dt ③	-5.5	V/ns
T_J	Operating Junction	-55 to 150	°C
T_{STG}	Storage Temperature Range		
	Lead Temperature	300 (0.063 in.(1.6mm) from case for 10s)	
	Weight	9.3 (typical)	g

For footnotes refer to the last page

Electrical Characteristics @ Tj = 25°C (Unless Otherwise Specified)

	Parameter	Min	Typ	Max	Units	Test Conditions
BV_{DSS}	Drain-to-Source Breakdown Voltage	-100	—	—	V	V_{GS} = 0V, I_D = -1.0mA
$\Delta BV_{DSS}/\Delta T_J$	Temperature Coefficient of Breakdown Voltage	—	-0.087	—	V/°C	Reference to 25°C, I_D = -1.0mA
$R_{DS(on)}$	Static Drain-to-Source On-State Resistance	—	—	0.20	Ω	V_{GS} = -10V, I_D = -11A④
		—	—	0.22		V_{GS} = -10V, I_D = -18A ④
$V_{GS(th)}$	Gate Threshold Voltage	-2.0	—	-4.0	V	V_{DS} = V_{GS}, I_D = -250µA
g_{fs}	Forward Transconductance	6.2	—	—	S (℧)	V_{DS} > -15V, I_{DS} = -11A④
I_{DSS}	Zero Gate Voltage Drain Current	—	—	-25	µA	V_{DS}= -80V, V_{GS}= 0V
		—	—	-250		V_{DS} = -80V, V_{GS} = 0V, T_J = 125°C
I_{GSS}	Gate-to-Source Leakage Forward	—	—	-100	nA	V_{GS} = -20V
I_{GSS}	Gate-to-Source Leakage Reverse	—	—	100		V_{GS} =20V
Q_g	Total Gate Charge	—	—	60	nC	V_{GS} = -10V, ID= -18A
Q_{gs}	Gate-to-Source Charge	—	—	13		V_{DS} = -50V
Q_{gd}	Gate-to-Drain ('Miller') Charge	—	—	35.2		
$t_{d(on)}$	Turn-On Delay Time	—	—	35	ns	V_{DD} = -50V, I_D = -11A
t_r	Rise Time	—	—	85		R_G = 9.1Ω, V_{GS} = -10V
$t_{d(off)}$	Turn-Off Delay Time	—	—	85		
t_f	Fall Time	—	—	65		
$L_S + L_D$	Total Inductance	—	6.8	—	nH	Measured from drain lead (6mm/ 0.25in. from package) to source lead (6mm/0.25in. from package)
C_{iss}	Input Capacitance	—	1400		pF	V_{GS} = 0V, V_{DS} = -25V
C_{oss}	Output Capacitance	—	600	—		f = 1.0MHz
C_{rss}	Reverse Transfer Capacitance	—	200	—		

Source-Drain Diode Ratings and Characteristics

	Parameter	Min	Typ	Max	Units	Test Conditions
I_S	Continuous Source Current (Body Diode)	—	—	-18	A	
I_{SM}	Pulse Source Current (Body Diode) ①	—	—	-72		
V_{SD}	Diode Forward Voltage	—	—	-5.0	V	T_j = 25°C, I_S = -18A, V_{GS} = 0V ④
t_{rr}	Reverse Recovery Time	—	—	280	nS	Tj = 25°C, I_F = -18A, di/dt ≤-100A/µs
Q_{RR}	Reverse Recovery Charge	—	—	3.6	µc	V_{DD} ≤ -50V ④
t_{on}	Forward Turn-On Time	Intrinsic turn-on time is negligible. Turn-on speed is substantially controlled by L_S + L_D.				

Thermal Resistance

	Parameter	Min	Typ	Max	Units	Test Conditions
R_{thJC}	Junction-to-Case	—	—	1.0	°C/W	
R_{thCS}	Case-to-sink	—	0.21	—		
R_{thJA}	Junction to Ambient	—	—	48		Typical socket mount

Note: Corresponding Spice and Saber models are available on International Rectifier Website.

For footnotes refer to the last page

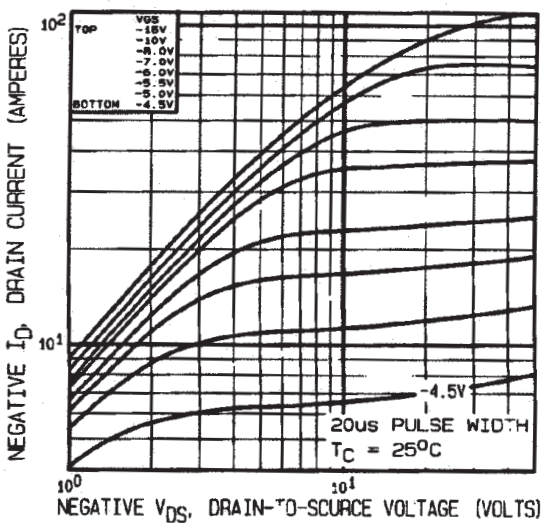


Fig 1. Typical Output Characteristics

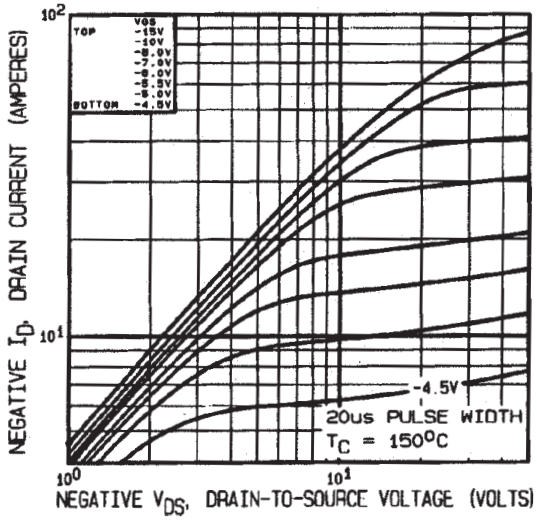


Fig 2. Typical Output Characteristics

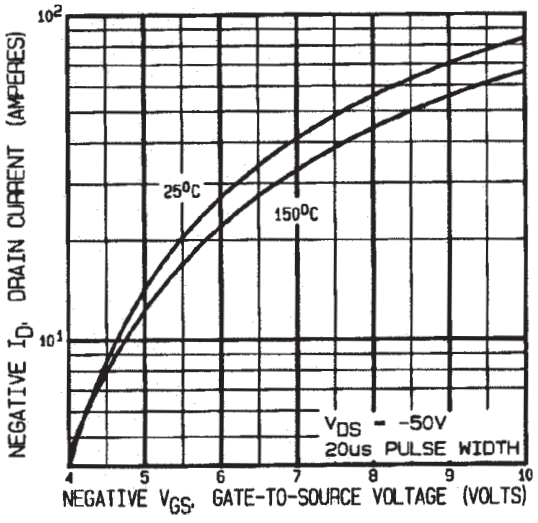


Fig 3. Typical Transfer Characteristics

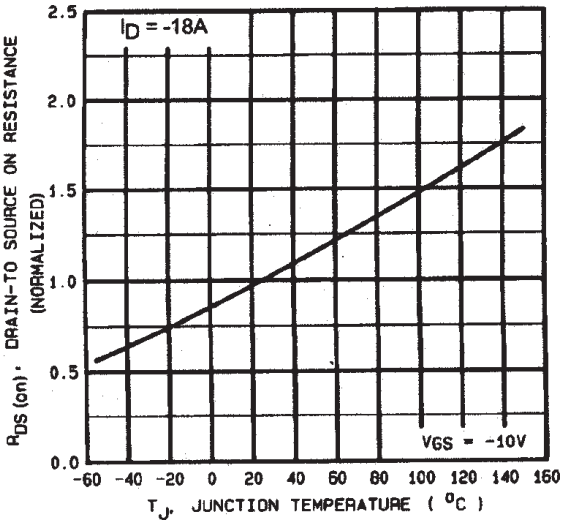


Fig 4. Normalized On-Resistance Vs. Temperature

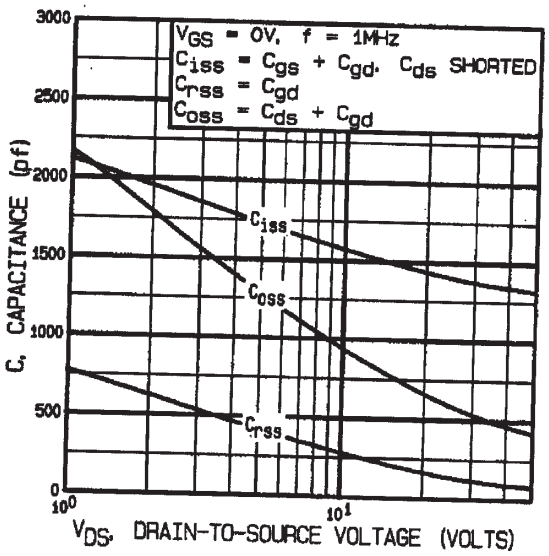


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

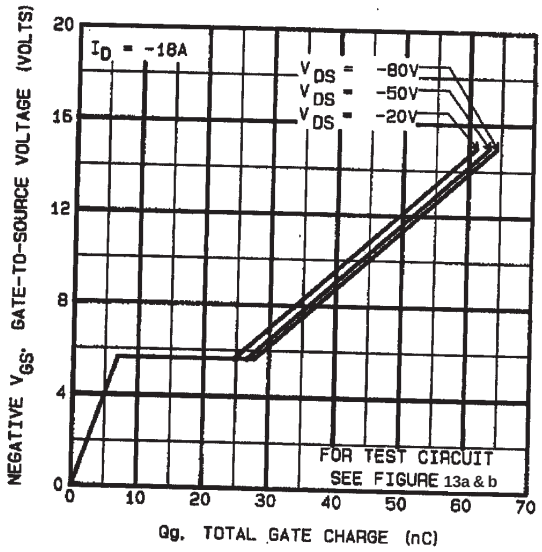


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

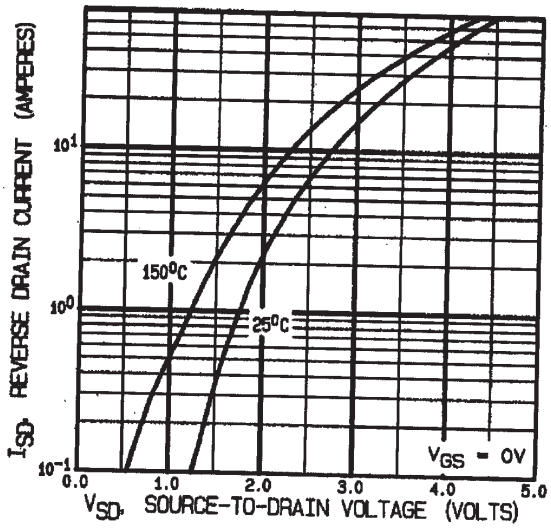


Fig 7. Typical Source-Drain Diode Forward Voltage

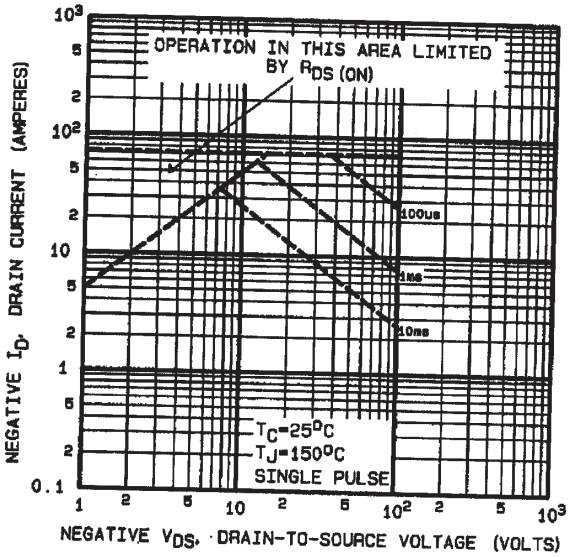


Fig 8. Maximum Safe Operating Area

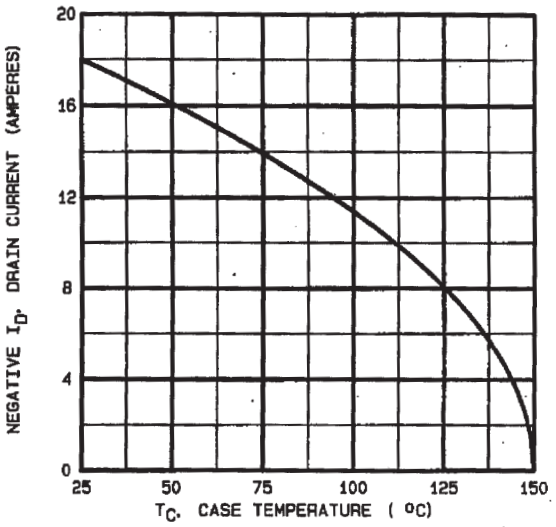


Fig 9. Maximum Drain Current Vs. Case Temperature

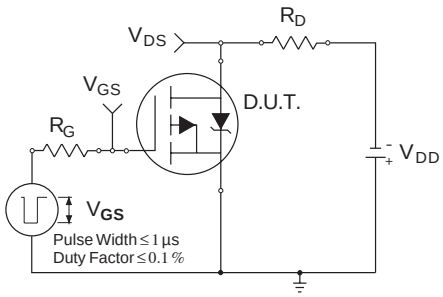


Fig 10a. Switching Time Test Circuit

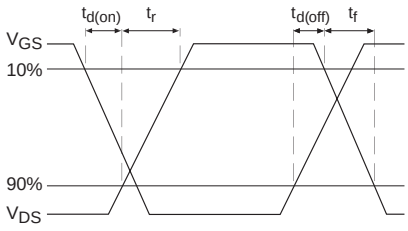


Fig 10b. Switching Time Waveforms

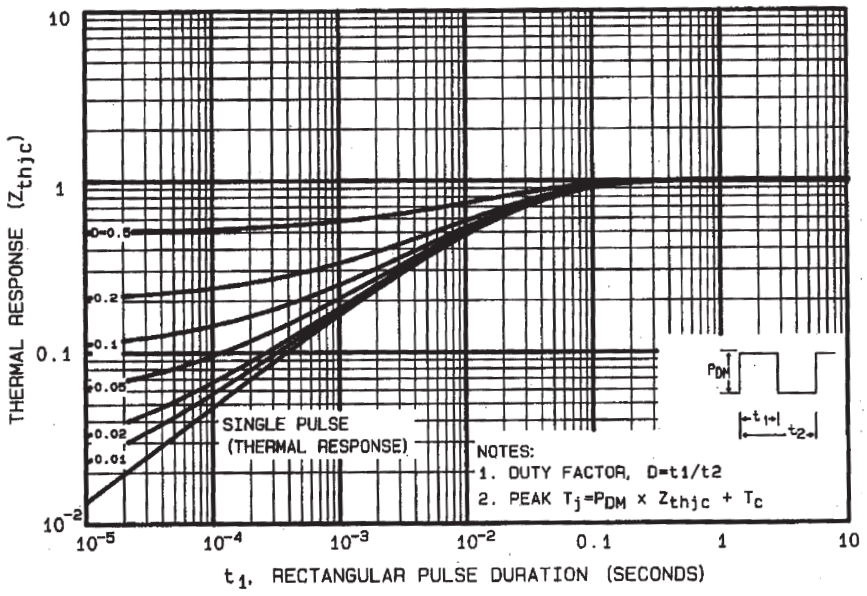


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

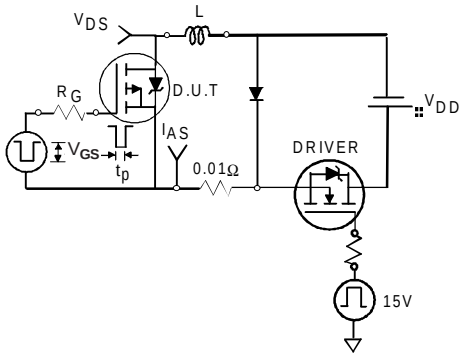


Fig 12a. Unclamped Inductive Test Circuit

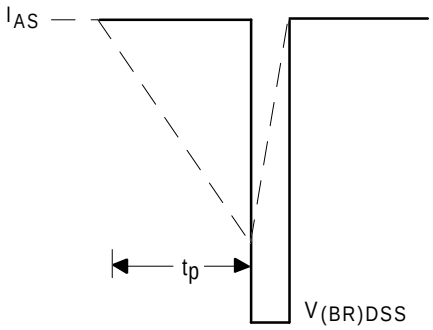


Fig 12b. Unclamped Inductive Waveforms

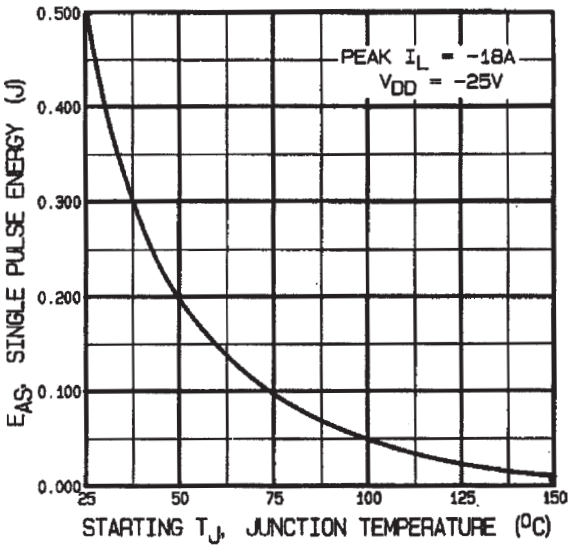


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

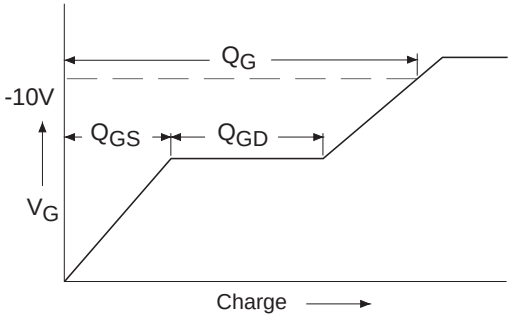


Fig 13a. Basic Gate Charge Waveform

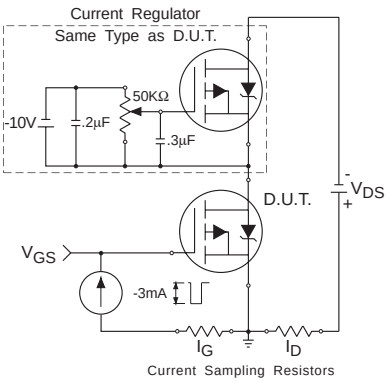


Fig 13b. Gate Charge Test Circuit

Foot Notes:

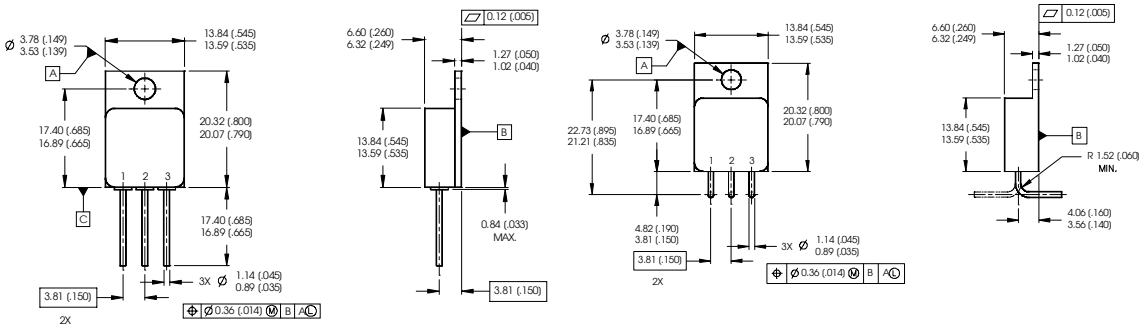
① Repetitive Rating; Pulse width limited by maximum junction temperature.

② V_{DD} =-25V, starting T_J = 25°C, L = 3.1mH Peak I_L = -18A, V_{GS} = -10V

③ I_{SD} ≤ -18A, di/dt ≤ –100A/μs, V_{DD}≤ -100V, T_J ≤ 150°C

④ Pulse width ≤ 300 μs; Duty Cycle ≤ 2%

Case Outline and Dimensions — TO-254AA



NOTES:

1. DIMENSIONING & TOLERANCING PER ASME Y14.5M-1994.
2. ALL DIMENSIONS ARE SHOWN IN MILLIMETERS (INCHES).
3. CONTROLLING DIMENSION: INCH.
4. CONFORMS TO JEDEC OUTLINE TO-254AA.

PIN ASSIGNMENTS

1 = DRAIN
2 = SOURCE
3 = GATE

CAUTION

BERYLLIA WARNING PER MIL-PRF-19500

Packages containing beryllia shall not be ground, sandblasted, machined or have other operations performed on them which will produce beryllia or beryllium dust. Furthermore, beryllium oxide packages shall not be placed in acids that will produce fumes containing beryllium.

International
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>>Infineon Technologies(英飞凌)